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FSTD16861 20-Bit Bus Switch with Level Shifting

General Description

The Fairchild Switch FSTD16861 provides 20-bits of high-speed CMOS TTL-compatible bus switching. The low On Resistance of the switch allows inputs to be connected to outputs without adding propagation delay or generating additional ground bounce noise. A diode to V_{CC} has been integrated into the circuit to allow for level shifting between 5V inputs and 3.3V outputs.

The device is organized as a 10-bit or 20-bit bus switch. When \overline{OE}_1 is LOW, the switch is ON and Port 1A is connected to Port 1B. When \overline{OE}_2 is LOW, Port 2A is connected to Port 2B. When \overline{OE}_X is HIGH, a high impedance state exists between the A and B Ports.

Features

- 4 Ω switch connection between two ports.
- Minimal propagation delay through the switch.
- Low I_{CC} .
- Zero bounce in flow-through mode.
- Control inputs compatible with TTL level.
- TruTranslation™ voltage translation from 5.0V inputs to 3.3V outputs
- Power-off high impedance inputs and outputs
- Supports live insertion/withdrawal (Note 1)

Note 1: To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pull-up resistor; the minimum value of the resistor is determined by the current-sourcing capability of the driver.

Ordering Code:

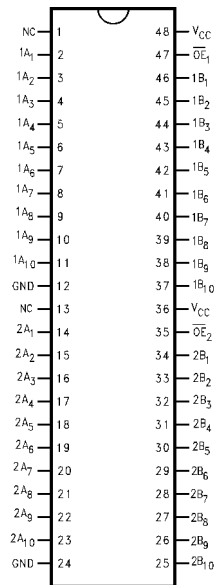
| Order Number | Package Number | Package Description |
|--------------|----------------|---|
| FSTD16861MTD | MTD48 | 48-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 6.1mm Wide |

Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

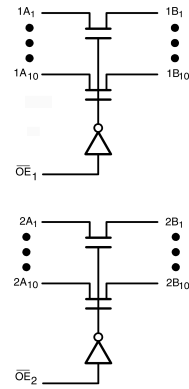
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FSTD16861 20-Bit Bus Switch with Level Shifting

Connection Diagram



Logic Diagram



Pin Descriptions

| Pin Name | Description |
|------------------------------------|--------------------|
| $\overline{OE}_1, \overline{OE}_2$ | Bus Switch Enables |
| 1A _n , 2A _n | Bus A |
| 1B _n , 2B _n | Bus B |

Truth Table

| Inputs | | Inputs/Outputs | |
|-------------------|-------------------|----------------|---------|
| \overline{OE}_1 | \overline{OE}_2 | 1A, 1B | 2A, 2B |
| L | L | 1A = 1B | 2A = 2B |
| L | H | 1A = 1B | Z |
| H | L | Z | 2A = 2B |
| H | H | Z | Z |

H = HIGH Voltage Level
 L = LOW Voltage Level
 Z = High Impedance

Absolute Maximum Ratings(Note 2)

| | |
|---|------------------|
| Supply Voltage (V_{CC}) | -0.5V to +7.0V |
| DC Switch Voltage (V_S) (Note 3) | -0.5V to +7.0V |
| DC Input Voltage (V_{IN}) (Note 4) | -0.5V to +7.0V |
| DC Input Diode Current (I_{IK}) $V_{IN} < 0V$ | -50 mA |
| DC Output Current (I_{OUT}) | 128 mA |
| DC V_{CC}/GND Current (I_{CC}/I_{GND}) | ± 100 mA |
| Storage Temperature Range (T_{STG}) | -65°C to +150 °C |

Recommended Operating Conditions (Note 5)

| | |
|--|------------------|
| Power Supply Operating (V_{CC}) | 4.5V to 5.5V |
| Input Voltage (V_{IN}) | 0V to 5.5V |
| Output Voltage (V_{OUT}) | 0V to 5.5V |
| Input Rise and Fall Time (t_r, t_f) | |
| Switch Control Input | 0 ns/V to 5 ns/V |
| Switch I/O | 0 ns/V to DC |
| Free Air Operating Temperature (T_A) | -40 °C to +85 °C |

Note 2: The "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the absolute maximum rating. The "Recommended Operating Conditions" table will define the conditions for actual device operation.

Note 3: V_S is the voltage observed/applied at either the A or B Ports across the switch.

Note 4: The input and output negative voltage ratings may be exceeded if the input and output diode current ratings are observed.

Note 5: Unused control inputs must be held HIGH or LOW. They may not float.

DC Electrical Characteristics

| Symbol | Parameter | V_{CC} (V) | $T_A = -40\text{ }^\circ\text{C to } +85\text{ }^\circ\text{C}$ | | | Units | Conditions |
|-----------------|----------------------------------|-----------------|---|-----------------|-----------|---------------|---|
| | | | Min | Typ (Note 6) | Max | | |
| V_{IK} | Clamp Diode Voltage | 4.5 | | | -1.2 | V | $I_{IN} = -18\text{ mA}$ |
| V_{IH} | HIGH Level Input Voltage | 4.5-5.5 | 2.0 | | | V | |
| V_{IL} | LOW Level Input Voltage | 4.5-5.5 | | | 0.8 | V | |
| V_{OH} | HIGH Level | 4.5-5.5 | See Figure 3 | | | V | |
| I_I | Input Leakage Current | 5.5 | | | ± 1.0 | μA | $0 \leq V_{IN} \leq 5.5V$ |
| | | 0 | | | 10 | μA | $V_{IN} = 5.5V$ |
| I_{OZ} | OFF-STATE Leakage Current | 5.5 | | | ± 1.0 | μA | $0 \leq A, B \leq V_{CC}$ |
| R_{ON} | Switch On Resistance (Note 7) | 4.5 | | 4 | 7 | Ω | $V_{IN} = 0V, I_{IN} = 64\text{ mA}$ |
| | | 4.5 | | 4 | 7 | Ω | $V_{IN} = 0V, I_{IN} = 30\text{ mA}$ |
| | | 4.5 | | 35 | 50 | Ω | $V_{IN} = 2.4V, I_{IN} = 15\text{ mA}$ |
| I_{CC} | Quiescent Supply Current | 5.5 | | | 1.5 | mA | $OE_1 = OE_2 = GND$ $V_{IN} = V_{CC}$ or $GND, I_{OUT} = 0$ |
| | | | | | 10 | μA | $OE_1 = OE_2 = V_{CC}$ $V_{IN} = V_{CC}$ or $GND, I_{OUT} = 0$ |
| ΔI_{CC} | Increase in I_{CC} per Input | 5.5 | | | 2.5 | mA | One Input at 3.4V Other Inputs at V_{CC} or GND |

Note 6: Typical values are at $V_{CC} = 5.0V$ and $T_A = +25^\circ\text{C}$

Note 7: Measured by the voltage drop between A and B pins at the indicated current through the switch. On Resistance is determined by the lower of the voltages on the two (A or B) pins.

AC Electrical Characteristics

| Symbol | Parameter | $T_A = -40\text{ }^\circ\text{C to } +85\text{ }^\circ\text{C}$, $C_L = 50\text{pF}$, $R_U = R_D = 500\Omega$ | | Units | Conditions | Figure Number |
|-----------------------|---------------------------------------|--|------|-------|--|---------------|
| | | $V_{CC} = 4.5 - 5.5\text{V}$ | | | | |
| | | Min | Max | | | |
| t_{PHL} , t_{PLH} | Propagation Delay Bus-to-Bus (Note 8) | | 0.25 | ns | $V_I = \text{OPEN}$ | Figures 1, 2 |
| t_{PZH} , t_{PZL} | Output Enable Time | 1.0 | 6.0 | ns | $V_I = 7\text{V}$ for t_{PZL} $V_I = \text{OPEN}$ for t_{PZH} | Figures 1, 2 |
| t_{PHZ} , t_{PLZ} | Output Disable Time | 1.0 | 7.0 | ns | $V_I = 7\text{V}$ for t_{PLZ} $V_I = \text{OPEN}$ for t_{PHZ} | Figures 1, 2 |

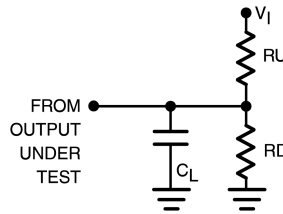
Note 8: This parameter is guaranteed by design but is not tested. The bus switch contributes no propagation delay other than the RC delay of the typical On Resistance of the switch and the 50pF load capacitance, when driven by an ideal voltage source (zero output impedance).

Capacitance (Note 9)

| Symbol | Parameter | Typ | Max | Units | Conditions |
|-----------|--------------------------------------|-----|-----|-------|--|
| C_{IN} | Control Pin Input Capacitance | 3 | | pF | $V_{CC} = 5.0\text{V}$, $V_{IN} = 0\text{V}$ |
| $C_{I/O}$ | Input/Output Capacitance "OFF State" | 6 | | pF | $V_{CC}, \overline{OE} = 5.0\text{V}$, $V_{IN} = 0\text{V}$ |

Note 9: $T_A = +25\text{ }^\circ\text{C}$, $f = 1\text{ MHz}$, Capacitance is characterized but not tested.

AC Loading and Waveforms



Note: Input driven by 50Ω source terminated in 50Ω

Note: C_L includes load and stray capacitance

Note: Input PRR = 1.0 MHz, $t_W = 500\text{ ns}$

FIGURE 1. AC Test Circuit

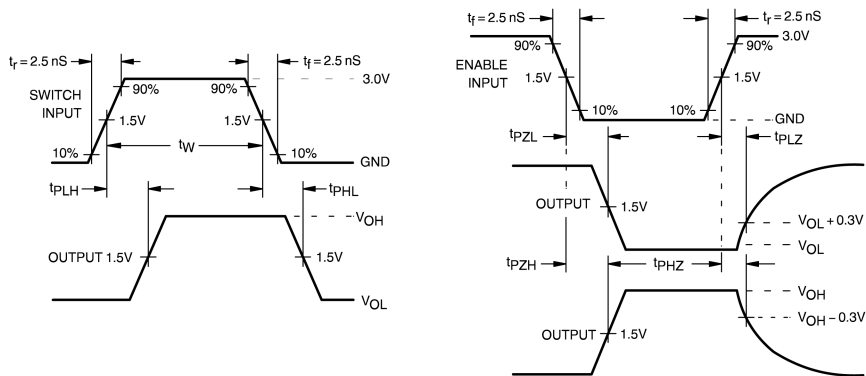


FIGURE 2. AC Waveforms

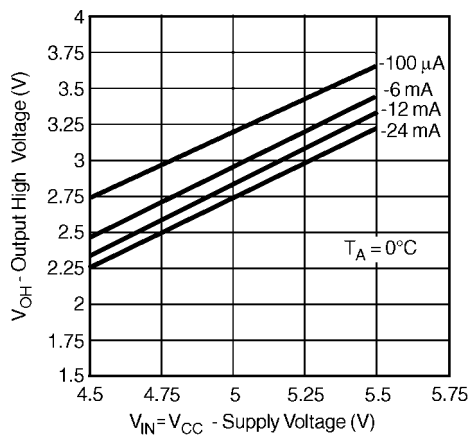
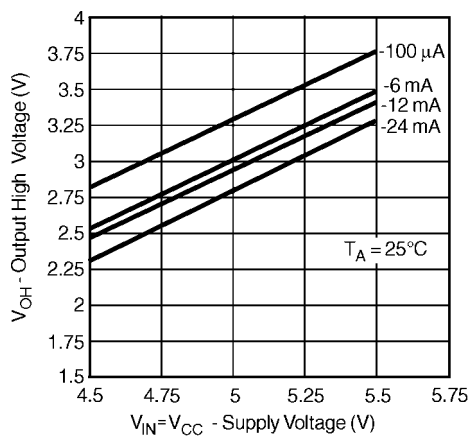
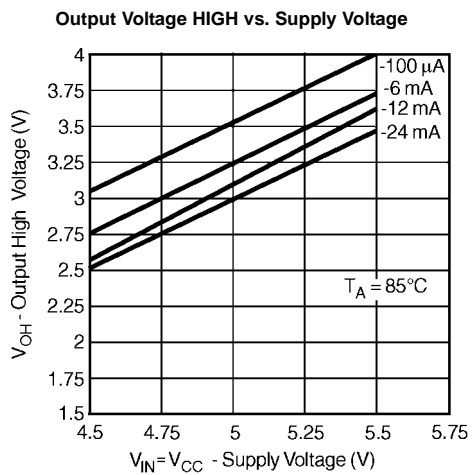
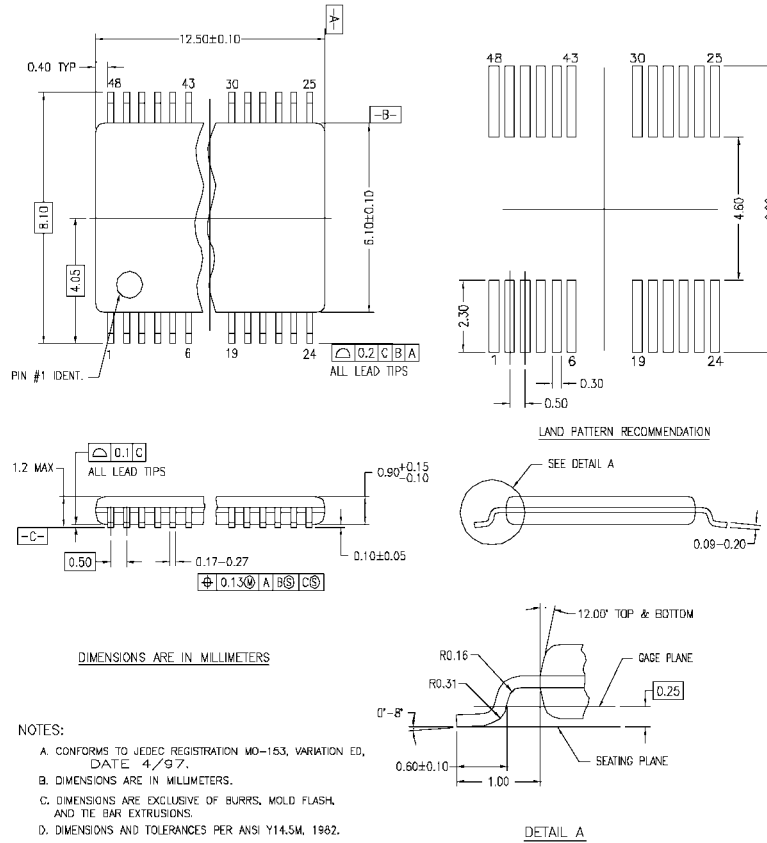


FIGURE 3.

Physical Dimensions inches (millimeters) unless otherwise noted



MTD48REVC

**48-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 6.1mm Wide
Package Number MTD48**

Technology Description

The Fairchild Switch family derives from and embodies Fairchild's proven switch technology used for several years in its 74LVX3L384(FST3384) bus switch product.

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